## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant. Edward A. Schrock et al.

Title:

METHOD FOR ATTACHING A SEMICONDUCTOR DIE TO A SUBSTRATE

Docket No.:

303.527US2

Serial No.: 09/649,827

Filed:

August 29, 2000

Due Date: April 15, 2003

Examiner: Geoffrey L. Knable

Group Art Unit: 1733

Commissioner for Patents Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

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APR 2 3 7003

 $\underline{X}$  A return postcard.

X An Amendment and Response (12 Pages).

**GROUP 1700** 

If an additional fee is required due to changes to the claims, the fee has been calculated as follows:

		CL	AIMS AS AMENDE	D		
	(1) Claims Remaining After Amendment		(2) Highest Number Previously Paid For	(3) Present Extra	Rate	Fee
TOTAL CLAIMS	29	-	30		x 18 =	\$0.00
INDEPENDENT CLAIMS	6	-	8		x 84 =	\$0.00
[ ] MULTIPLE DEPENDENT CLAIMS PRESENTED						\$0.00
TOTAL						\$0.00

Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional required fees or credit overpayment to Deposit Account No. 19-0743

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<u>CERTIFICATE UNDER 37 CFR 1.8:</u> The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on this <u>15th</u> day of <u>April</u>, 2003.

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PATENT DEMARK OFFICE

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AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

ommissioner for Patents Washington, D.C. 20231

This paper is in response to the Office Action mailed on January 15, 2003. Please amend the above-identified patent application as follows.

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